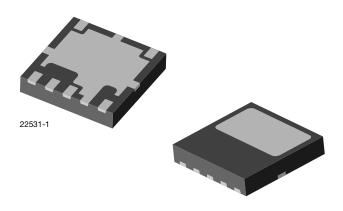


RoHS

HALOGEN FREE

GREEN

IR Receiver Modules for Remote Control Systems



ORDERING CODE

Taping:

TSOP57...TT1 - top view taped TSOP57...TT2 - top view taped

FEATURES

- · Improved immunity against HF and RF noise
- · Height of 0.8 mm
- ± 75° half angle sensitivity
- · Low supply current
- Photo detectors and preamplifier in one package
- Internal filter for PCM frequency
- Supply voltage: 2.5 V to 5.5 V, typically even 2.0 V to 5.5 V is possible
- Improved immunity against optical noise
- Insensitive to supply voltage ripple and noise
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

The TSOP57... series are miniaturized SMD IR receiver modules for infrared remote control systems. A PIN diode and a preamplifier are assembled on a PCB, the epoxy package contains an IR filter.

The demodulated output signal can be directly connected to a microprocessor for decoding.

The TSOP574.. series devices are optimized to suppress almost all spurious pulses from Wi-Fi and CFL sources. They may suppress some data signals if continuously transmitted.

The TSOP572.. series devices are provided primarily for compatibility with old AGC2 designs. New designs should prefer the TSOP574.. series containing the newer AGC4.

These components have not been qualified according to automotive specifications.

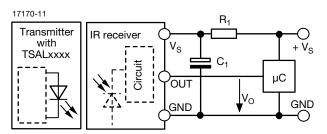
| PARTS T | ABLE | | | |
|--------------------------|-------------|--|---|--|
| AGC | | LEGACY, FOR LONG BURST REMOTE CONTROLS (AGC2) | RECOMMENDED FOR LONG BURST CODES (AGC4) | |
| | 36 kHz | TSOP57236 | TSOP57436 (1)(2)(3) | |
| Carrier | 38 kHz | TSOP57238 | TSOP57438 (4)(5) | |
| frequency | 40 kHz | TSOP57240 | TSOP57440 | |
| | 56 kHz | TSOP57256 | TSOP57456 (6)(7) | |
| Package | | Belobog | | |
| Pinning | | 1 = OUT, 2, 3, 6, 7, 8 = GND, 4, 5 = V _S | | |
| Dimensions (mm) | | 3.95 W x 3.95 H x 0.8 D | | |
| Mounting | ounting SMD | | D | |
| Application | | Remote control | | |
| Best remote control code | | (1) RC-5 (2) RC-6 (3) Panasonic (4) NEC (5) Sharp (6) r-step (7) Thomson RCA | | |



BLOCK DIAGRAM

4, 5 V_s 33 kΩ 1 OUT pass Demodulator pass 2, 3, 6, 7, 8 GND

APPLICATION CIRCUIT



 R_1 and C_1 recommended to reduce supply ripple for $V_S < 2.8 \text{ V}$

| ABSOLUTE MAXIMUM RA | UTE MAXIMUM RATINGS | | | |
|-----------------------------|--------------------------|------------------|--------------------------------|------|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT |
| Supply voltage | | V _S | -0.3 to +6 | V |
| Supply current | | I _S | 5 | mA |
| Output voltage | | Vo | -0.3 to (V _S + 0.3) | V |
| Output current | | I _O | 5 | mA |
| Junction temperature | | Tj | 100 | °C |
| Storage temperature range | | T _{stg} | -25 to +85 | °C |
| Operating temperature range | | T _{amb} | -25 to +85 | °C |
| Power consumption | T _{amb} ≤ 85 °C | P _{tot} | 10 | mW |

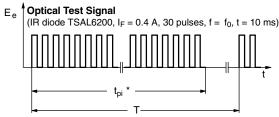
Note

• Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

| ELECTRICAL AND OPTI | CAL CHARACTERISTICS | (T _{amb} = 25 ° | °C, unless o | otherwise s | pecified) | |
|-----------------------|--|--------------------------|--------------|-------------|-----------|-------------------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Supply voltage | | Vs | 2.5 | - | 5.5 | V |
| Supply ourrent | $V_{S} = 5 V, E_{V} = 0$ | I _{SD} | 0.55 | 0.7 | 0.9 | mA |
| Supply current | $E_v = 40$ klx, sunlight | I _{SH} | - | 0.8 | - | mA |
| Transmission distance | $E_v = 0$, IR diode TSAL6200, $I_F = 250$ mA, test signal see Fig. 1 | d | - | 40 | - | m |
| Output voltage low | $I_{OSL} = 0.5 \text{ mA}, E_e = 0.7 \text{ mW/m}^2,$ test signal see Fig. 1 | V _{OSL} | - | - | 100 | mV |
| Minimum irradiance | Pulse width tolerance: t_{pi} - $5/f_o < t_{po} < t_{pi} + 6/f_o$, test signal see Fig. 1 | E _{e min.} | - | 0.2 | 0.4 | mW/m ² |
| Maximum irradiance | t_{pi} - 5/f _o < t_{po} < t_{pi} + 6/f _o , test signal see Fig. 1 | E _{e max.} | 50 | - | - | W/m² |
| Directivity | Angle of half transmission distance | Ψ1/2 | - | ± 75 | - | deg |



TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)



* $t_{pi} \ge 10/f_0$ is recommended for optimal function

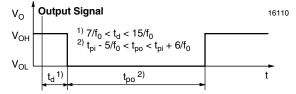


Fig. 1 - Output Active Low

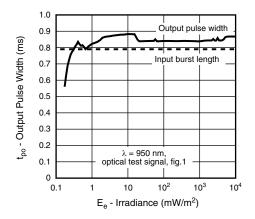
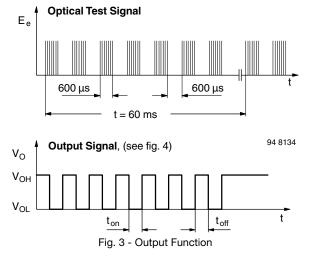


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient



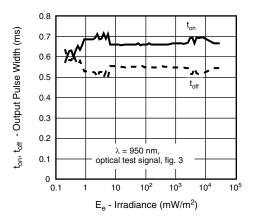


Fig. 4 - Output Pulse Diagram

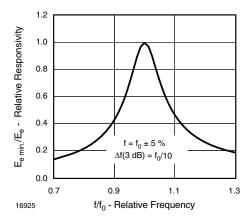


Fig. 5 - Frequency Dependance of Responsivity

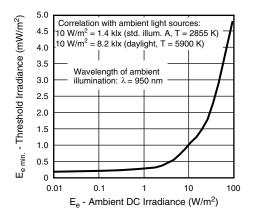


Fig. 6 - Sensitivity in Bright Ambient

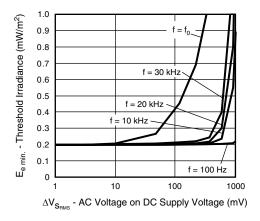


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

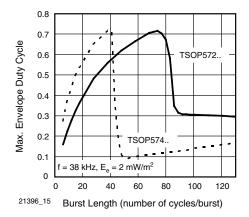


Fig. 8 - Max. Envelope Duty Cycle vs. Burst Length

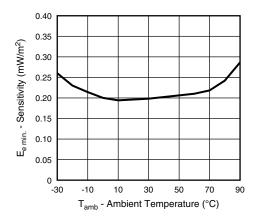


Fig. 9 - Sensitivity vs. Ambient Temperature

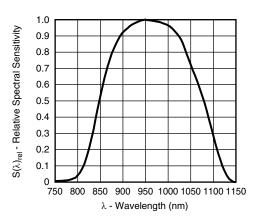


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength

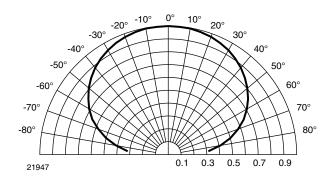


Fig. 11 - Horizontal Directivity

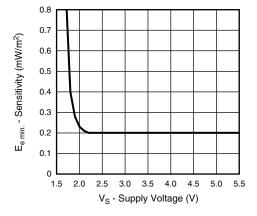


Fig. 12 - Sensitivity vs. Supply Voltage



SUITABLE DATA FORMAT

The TSOP572.., TSOP574.. series is designed to suppress spurious output pulses due to noise or disturbance signals. The devices can distinguish data signals from noise due to differences in frequency, burst length, and envelope duty cycle. The data signal should be close to the device's band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the TSOP572.., TSOP574.. in the presence of a disturbance, the sensitivity of the receiver is automatically reduced by the AGC to insure that no spurious pulses are present at the receiver's output. Some examples which are suppressed are:

- DC light (e.g. from tungsten bulbs sunlight)
- · Continuous signals at any frequency
- Strongly or weakly modulated patterns from fluorescent lamps with electronic ballasts (see Fig. 13 or Fig. 14)
- 2.4 GHz and 5 GHz Wi-Fi

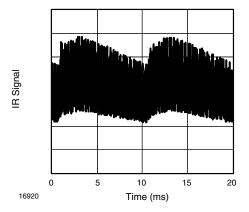


Fig. 13 - IR Signal from Fluorescent Lamp with Low Modulation

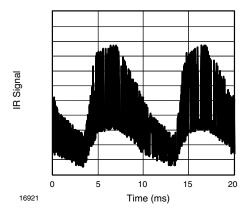


Fig. 14 - IR Signal from Fluorescent Lamp with High Modulation

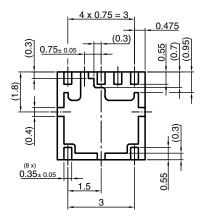
| | TSOP572 | TSOP574 |
|--|---|---|
| Minimum burst length | 10 cycles/burst | 10 cycles/burst |
| After each burst of length a minimum gap time is required of | 10 to 70 cycles ≥ 10 cycles | 10 to 42 cycles ≥ 10 cycles |
| For bursts greater than a minimum gap time in the data stream is needed of | 70 cycles > 4 x burst length | 42 cycles > 10 x burst length |
| Maximum number of continuous short bursts/second | 800 | 1300 |
| NEC code | Yes | Preferred |
| RC5/RC6 code | Yes | Preferred |
| Thomson 56 kHz code | Yes | Preferred |
| Suppression of interference from fluorescent lamps | Mild disturbance patterns are suppressed (example: signal pattern of Fig. 13) | Complex and critical disturbance patterns are suppressed (example: signal pattern of Fig. 14 or highly dimmed LCDs) |

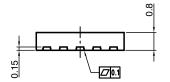
Note

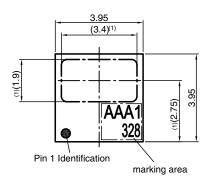
For data formats with short bursts please see the datasheet for TSOP573...



PACKAGE DIMENSIONS in millimeters

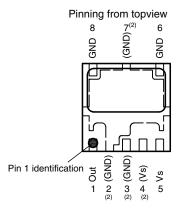




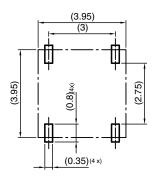


Drawing-No.: 6.550-5315.01-4 Issue: 2; 12.02.14

Not indicated tolerances ± 0.1 technical drawings according to DIN specifications



Proposed pad layout from component side (dim. for reference only)



Notes

(1) Optically effective area

(2) Pins connected internally. It is not necessary to connect externally.



ASSEMBLY INSTRUCTIONS

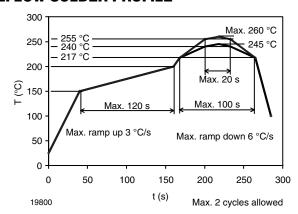
Reflow Soldering

- Reflow soldering must be done within 168 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

Manual Soldering

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off

VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE

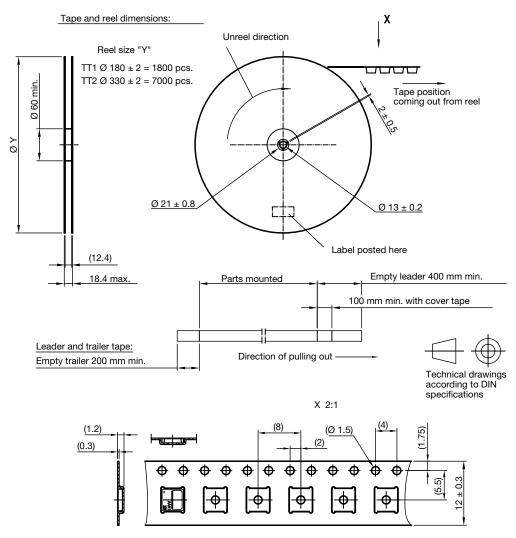


| ORDERING INFORMATION | | | |
|----------------------|---------------|---------------|-----------------------------------|
| ORDERING CODE | PACKAGING | VOLUME (1) | REMARKS |
| TSOP57TT1 | Tape and reel | MOQ: 1800 pcs | 3.95 mm x 3.95 mm x 0.75 mm |
| TSOP57TT2 | rape and reei | MOQ: 7000 pcs | 3.95 Hill X 3.95 Hill X 0.75 Hill |

Note

(1) MOQ: minimum order quantity

TAPING VERSION TSOP57... DIMENSIONS in millimeters



Drawing-No.: 9.700-5347.01-4

Issue: 1; 14.11.11

Not indicated tolerances ± 0.1

LABEL

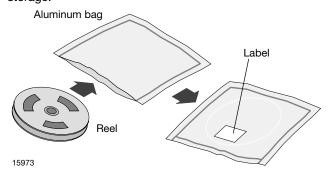
Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

| PLAIN WRITING | ABBREVIATION | LENGTH |
|-----------------------|--------------|--------------|
| Item-description | - | 18 |
| Item-number | INO | 8 |
| Selection-code | SEL | 3 |
| LOT-/serial-number | BATCH | 10 |
| Data-code | COD | 3 (YWW) |
| Plant-code | PTC | 2 |
| Quantity | QTY | 8 |
| Accepted by | ACC | - |
| Packed by | PCK | - |
| Mixed code indicator | MIXED CODE | - |
| Origin | xxxxxx+ | Company logo |
| Long bar code top | Туре | Length |
| Item-number | N | 8 |
| Plant-code | N | 2 |
| Sequence-number | X | 3 |
| Quantity | N | 8 |
| Total length | - | 21 |
| Short bar code bottom | Туре | Length |
| Selection-code | X | 3 |
| Data-code | N | 3 |
| Batch-number | X | 10 |
| Filter | - | 1 |
| Total length | - | 17 |

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 168 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition: 192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC $^{\! (\! g \!)}$ standard J-STD-020 level 3 label is included on all dry bags.



www.vishay.com

Vishay Semiconductors

LEVEL Caution 3 This bag contains MOISTURE-SENSITIVE DEVICES 1. Calculated shelf life in sealed bag: 12 months at $<\!40^{\circ}\mathrm{C}$ and $<\!90\%$ relative humidity (RH) 3. After bag is opened, devices that will be subjected to reflow solder or other high temperature process must be a) Mounted within: $\frac{168}{\text{lf blank, see adjacent bar code label}}$ hours of factory conditions $\le\!30^\circ\text{C}/60^\circ\!\!\text{RH, or}$ b) Stored per J-STD-033 4. Devices require bake, before mounting, if: a) Humidity Indicator Card reads > 10% for level 2a - 5a devices or $>\!\!60\%$ for level 2 devices when read at 23±5°C b) 3a or 3b are not met 5. If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure If blank, see adjacent bar code label Note: Level and body temperature defined by IPC/JEDEC J-STD-020

EIA JEDEC standard J-STD-020 level 3 label is included on all dry bags

ESD PRECAUTION

22650

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

BAR CODE PRODUCT LABEL (example)



2217



Legal Disclaimer Notice

Vishay

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